

#### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>A</sub> = +25°C
60V	$2\Omega$ @ $V_{GS} = 4V$	310mA
607	$2.5\Omega$ @ $V_{GS} = 2.5V$	295mA

### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- DC-DC Converters
- **Power Management Functions**
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: X1-DFN1212-3
- Case Material: Molded Plastic. UL Flammability Classification
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 @4)
- Terminal Connections: See Diagram
- Weight: 0.005 grams (Approximate)

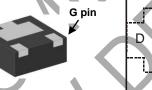


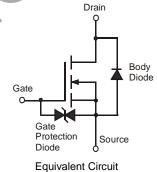


Top View



**Bottom View** 





Pin-Out Top View

## Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMN62D0LFD-7	Standard	X1-DFN1212-3	3,000/Tape & Reel
DMN62D0LFD-13	Standard	X1-DFN1212-3	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

**K63** 

K63 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017)M = Month (ex: 9 = September)

Date Code Key

Year	2007	2008	2009	2010	2011	20	12	2013	2014	2015	2016	2017
Code	U	V	W	Х	Υ	Z	7	Α	В	С	D	E
Month	Jan	Feb	Mar	Apr	May	Jun	Ju	ıl Au	g Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



#### NOT RECOMMENDED FOR NEW DESIGN **USE DMN62D1LFD**

DMN62D0LFD

### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	60	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = 4.0V	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	310 260	mA
Pulsed Drain Current (Note 6) (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	1.0	Α	

## Thermal Characteristics

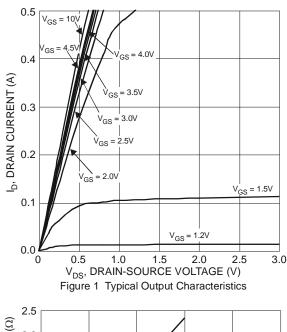
Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	0.48	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	R <sub>0JA</sub>	265	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-55 to +150	°C

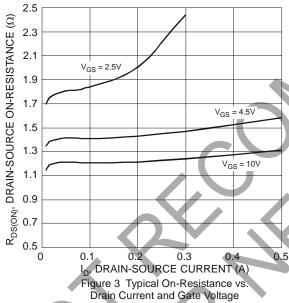
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

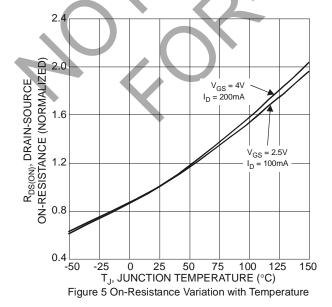
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	<u> </u>		V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	1	1	1.0	μA	$V_{DS} = 60V$ , $V_{GS} = 0V$
		1		±100	nA	$V_{GS} = \pm 5V$ , $V_{DS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_		±500	nA	$V_{GS} = \pm 10V$ , $V_{DS} = 0V$
		_	_	±2.0	μΑ	$V_{GS} = \pm 15V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.6	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
			1.3	2		$V_{GS} = 4V$ , $I_D = 100mA$
Static Drain-Source On-Resistance	D- over	<b>△</b> – ✓	1.4	2.5	Ω	$V_{GS} = 2.5V, I_D = 50mA$
Static Dialif-Source Off-Resistance	R <sub>DS</sub> (ON)		1.8	3	12	$V_{GS} = 1.8V, I_D = 50mA$
		_	2.4	_		$V_{GS} = 1.5V, I_D = 10mA$
Forward Transfer Admittance	Y <sub>fs</sub>	_	1.8	_	S	$V_{DS} = 10V, I_D = 200mA$
Diode Forward Voltage	V <sub>SD</sub>		0.8	1.3	V	$V_{GS} = 0V, I_S = 115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C <sub>iss</sub>	_	31	_		V 05V V 0V
Output Capacitance	Coss	_	4.3	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	3.0	_		1 - 1.011112
Gate Resistance	Rg		99	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge	Qg		0.5	_		V 45V V 40V
Gate-Source Charge	$Q_{gs}$	_	0.09	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Drain Charge	$Q_{gd}$	_	0.07	_		ID = 250IIIA
Turn-On Delay Time	t <sub>D(ON)</sub>	_	2.6	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	2.1	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	18	_	ns	$R_L = 150\Omega, R_G = 25\Omega,$ $I_D = 200 \text{mA}$
Turn-Off Fall Time	t <sub>F</sub>	_	8.7	_	ns	10 - 20011IA

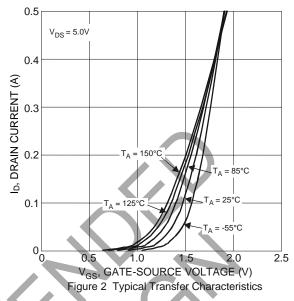
Notes:

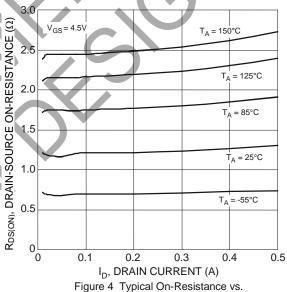
- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- Repetitive rating, pulse width limited by junction temperature.
   Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.











3.0  $R_{DS(ON)}$ , DRAIN-SOURCE ON-RESISTANCE  $(\Omega)$ 2.5 V<sub>GS</sub> = 2.5V I<sub>D</sub> = 100mA 2.0  $V_{GS} = 4V$  $I_{D} = 200 \text{mA}$ 1.5 1.0 0 -50 25 100 -25 50 75 125 T<sub>.I</sub>, JUNCTION TEMPERATURE (°C)

Drain Current and Temperature

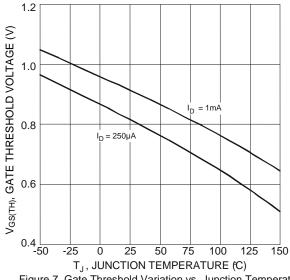
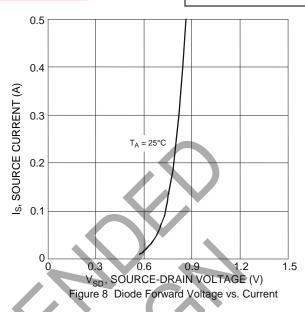
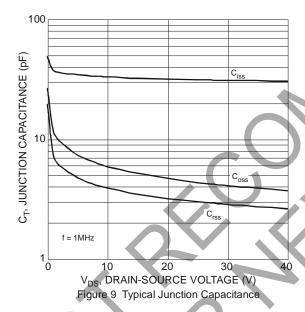


Figure 7 Gate Threshold Variation vs. Junction Temperature





V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V)  $V_{DS} = 10V$  $I_{D} = 250 \text{mA}$ 2 0, 0.2 0.4 0.6 8.0 1.0 1.2  $\mathbf{Q}_{\mathbf{g}},$  TOTAL GATE CHARGE (nC) Figure 10 Gate Charge

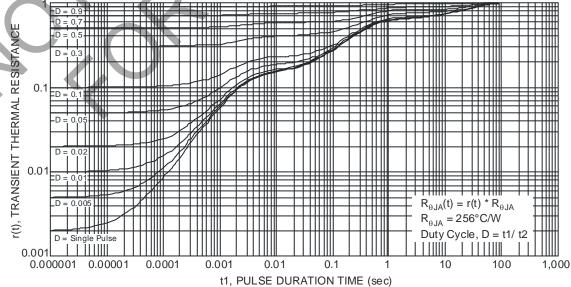


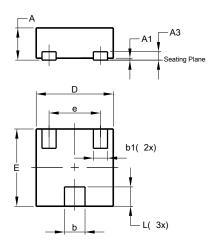
Figure 11 Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1212-3

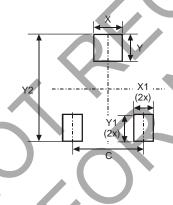


X1-DFN1212-3						
Dim	Min	Max	Тур			
Α	0.47	0.53	0.50			
A1	0	0.05	0.02			
A3	-	-	0.13			
b	0.27	0.37	0.32			
b1	0.17	0.27	0.22			
D	1.15	1.25	1.20			
Е	1.15	1.25	1.20			
е	-	-	0.80			
L	0.25	0.35	0.30			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## X1-DFN1212-3



Dimensions	Value (in mm)
С	0.80
Х	0.42
X1	0.32
Υ	0.50
Y1	0.50
Y2	1.50



# NOT RECOMMENDED FOR NEW DESIGN USE DMN62D1LFD

DMN62D0LFD

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